

**Minutes of the CE-2.0 National Connectors Standards Committee
16 – 17 April 2007
San Diego, CA**

Members Present				
Name	Organization or Company	Meeting Present		
		April 2007	September 2006	April 2006
Ralph Antonelli	DSCC-VAI	X	X	X
David Bouzek	Tri-Star Electronics	X	X	X
Bob Druckenmiller	FCI	X	X	X
H. John Healey, PhD	IBM	X	X	X
Arnold Offner	Phoenix Contact		X	X
Bill Peverill	WPA	X	X	
Kevin Rickard	Amphenol			X
Frank Ruffino (Chairman)	Molex Inc.	X	X	X
Carl Fritz (Vice Chairman)	Contech Research	X	X	X
Greg Brown	Glenair	X		
Members Absent				
Al Davis	Amphenol			
Max Peel	Contech Research			
Arun Shah	Cinch			
Jeff Toran	FCI Electronic			
Rick Zulkiewicz	Raytheon			
Others Present				
Ed Mikowski	EIA/ECA Staff	X	X	X
Bill O'Hirok	Chairman Emeritus	X		

Meeting number 40 of the National Connectors Standards Committee convened at 9:00 AM on 16 April 2007 by Chairman Frank Ruffino. It was noted that for the purpose of this meeting a quorum was met with the members present.

It is noted that all actions taken by the subcommittees will be simultaneously approved by the CE-2.0 committee.

1. REVIEW AND APPROVAL OF MINUTES

The minutes of meeting No. 39 held in Reno, NV were unanimously moved and approved as published. The motion was made by John Healey and seconded by Ralph Antonelli.

2. CHAIRMAN'S REPORT AND ANNOUNCEMENTS (Frank Ruffino, Chairman)

Frank presented a draft survey to address the issue of what we are doing or should be doing to entice more people to attend. The membership supported the survey. Also address was if we should be meeting in conjunction with any other organization instead of participating with the ECA Summit. For the time being we will send out the survey to current active member to get feed back on the survey it self.

Frank also reported that some consortia are beginning to reference EIA-364-1000.

Carl circulated the current EIA Contact Listing and will revise it based on this meeting. It should be noted that this is only a contact list and not an EIA member listing. (See Attachment No. 3)

3. SUBCOMMITTEE MEETINGS

CE-2.1 Test Procedures (Chairman: Carl Fritz, Vice Chairman, Max Peel)

Carl Fritz convened the test procedures subcommittee. (See Attachment No. 1 for meeting report).

CE-2.2 Connectors and Sockets Specifications (TBD)
(Was subcommittees CE-2.2, 2.3, 2.4 and 2.9)

Carl Fritz as facilitator convened the socket subcommittee. (See Attachment No. 2 for meeting report).

CE-2.3 Contact Specifications (Chairman: Dave Bouzek)
(Was subcommittee CE-2.6)

Nothing new to report at this time.

CE-2.4 Editing Subcommittee (Chairman: Carl Fritz)
(Was subcommittee CE-2.7)

Nothing new to report at this time, except to say that Carl Fritz provided John Healey with a format to generate a new TP.

CE-2.5 International Standards Subcommittee (Chairman: Jeff Toran)
(Was subcommittee CE-2.8)

A report by Jeff Toran was presented by Bob Druckenmiller (See Attachment No. 4). The next meeting is schedule for May 2007 in Copenhagen, Denmark. Bill O'Hirok asked if there was still a limit to the number of members that could attend IEC meetings from any one country.

Bill provided the following after the meeting:

He recalls that the limit of 5 members applies to the delegates to the meeting meaning no country could have more than 5 delegates. This was established so that no country could overwhelmingly dominate to the detriment of those countries that had only 1 or 2 members in their delegation. This decision took place in the 60's (I was a delegate/Chief US Delegate starting in 1960 until I retired from the USNC in 1988) and was still in force when I retired. Apparently the size of any country's delegation limitation changed since then.

Jeff Toran has provided the following in response to Bill's query for the minutes after the meeting:

For Working groups there is no restriction on the actual numbers of participants ("technical experts") from any one country. There are rules on how the experts are appointed to a working group. If any issues arise regarding the experts, they may be resolved at the Sub-committee or Technical committee level. Non-members of Working groups ("Observers") need to be invited to a meeting ahead of time and are only approved to attend that meeting.

Sub-committees (SC) and Technical committees (TC) do not have members per se. Each country appoints delegates to attend a Sub-committee and Technical committee meeting. These delegates are approved to attend only that meeting; hence they need to be "re-appointed" by their home country to any future meeting. The only "Observers" allowed to attend a Sub-committee or Technical committee are members from another SC or TC or other international committee. In all cases, there is still only the one vote per country.

4. WORKING GROUP MEETINGS

None active.

5. SPECIAL TASK GROUP MEETINGS

STG-13-2.0

SP-5037-A, EIA-622-A, Glossary of Electrical Connector Related Terms (Chairman: Ralph Antonelli)

Ralph reported that there were 6 approved ballots received and no comments or rejection. It was moved by Ralph Antonelli and seconded by Bob Druckenmiller to send the standard to EIA for EDEC ballot. The motion was unanimously approved.

6. LIASION REPORTS

A. DSCC, including Army, USAF, Navy; except NAVAIR (Ralph Antonelli)

Ralph presented his report (See Attachment No. 5).

B. NAVAIR (Dwight Tabit)

Ralph Antonelli to contact Dwight Tabit and see if he can provide anything for the minutes (See Attachment No. 8).

C. SAE/ISO (Dave Bouzek)

Dave Bouzek that the next meeting will be in Texas in May.

D. ASTM (Frank Ruffino)

Frank presented minutes of ASTM B02.11 Meeting, ASTM Headquarters, October 17, 2006 (See Attachment No. 6). Frank also provided the committee with the agenda for the ASTM B02.11 Subcommittee on Electric Contact Test Methods (phone meeting) scheduled for May 8, 2007, 10:30am (See Attachment No. 7).

E. IICIT

Dave Bouzek provided the following update on IICIT. Ronald Bishop, President of Bishop & Associates, Inc., will be the keynote speaker at the IICIT Connector & Interconnection Technology Symposium and Trade Show on May 8th and 9th in Dedham, MA.

The keynote presentation will be on The World Connector Industry with special focus on the industry outlook for 2007 and 2011.

Follow this link for more information and a registration form <<http://stats.expertmailer.com/sendlink.asp?HitID=1176818490000&StID=5119&SID=0&EmID=3486837&Link=http%3A%2F%2Fwww.iicit.org%2F>> .

7. OTHER BUSINESS

Documentation Structure Strategy (Carl Fritz)

To review the existing documentation structure for CE-2.0 and determine if an overhaul is required including the existence of Generic, Sectional and Blank Detail specifications. This includes those for connectors as well as sockets.

This question has been placed on the questionnaire. Bob Druckenmiller to ask Jeff Toran if it would hinder our standards from being accepted by the IEC if the current structure did not exist.

8. NEW BUSINESS

Note change web site title for EIA-364-1000.01

9. FUTURE MEETINGS

The ECA Fall Summit is scheduled for 24- 25 September 2007 in San Antonio, TX.

It was moved by Bob Druckenmiller and seconded by John Healey that all actions taken by the subcommittees' are unanimously approved.

The meeting adjourned at 11: 22 AM on 17 April 2007.

This meeting was conducted in accordance with EIA Legal Guidelines and EIA Manual for Organization and Procedure.

Respectfully submitted,

Frank Ruffino, Chairman CE-2.0

Prepared by
Carl Fritz, Secretary CE-2.0